

EYP-DFB-0780-00040-1500-BFY02-0x0x



We focus on power.

Revision 0.98

18.12.2012

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DISTRIBUTED FEEDBACK LASER

GaAs Semiconductor Laser Diode with integrated grating structure



General Product Information

Product	Application
780 nm DFB Laser with hermetic Butterfly Housing	Spectroscopy
Monitor Diode, Thermoelectric Cooler and Thermistor	Metrology
PM Fiber with angle-polished Connector	Rb Spectroscopy (Variant ...-0005)
High-reliable fully Space-qualified Package	

Absolute Maximum Ratings

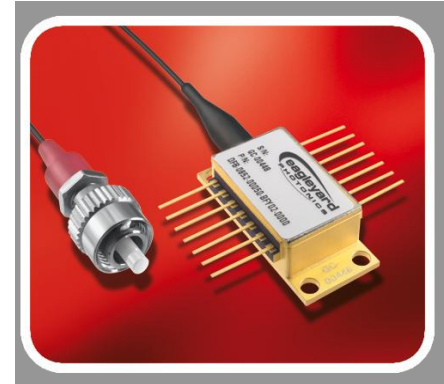
	Symbol	Unit	min	typ	max
Storage Temperature	T_S	°C	-40		85
Operational Temperature at Case	T_C	°C	-40		85
Operational Temperature at Laser Chip	T_{LD}	°C	0		50
Forward Current	I_F	mA			160
Reverse Voltage	V_R	V			2
Output Power	P_{opt}	mW			50
TEC Current	I_{TEC}	A			1.8
TEC Voltage	V_{TEC}	V			3.2

Recommended Operational Conditions

	Symbol	Unit	min	typ	max
Operational Temperature at Case	T_C	°C	-20		65
Operational Temperature at Laser Chip	T_{LD}	°C	5		45
Forward Current	I_F	mA			140
Output Power	P_{opt}	mW	4		40

Characteristics at Begin Of Life

Parameter	Symbol	Unit	min	typ	max
Center Wavelength	λ_C	nm	779	780	781
Spectral Width (FWHM)	$\Delta\nu$	MHz		2	
Temperature Coefficient of Wavelength	$d\lambda / dT$	nm / K		0.06	
Current Coefficient of Wavelength	$d\lambda / dI$	nm / mA		0.003	
Output Power @ $I_F = 140$ mA	P_{opt}	mW	40		



Stress in excess of the Absolute Maximum Ratings can cause permanent damage to the device.

Measurement Conditions / Comments

measured by integrated Thermistor

ex fiber

Measurement Conditions / Comments

see images on page 4

$P_{opt} = 40$ mW

$T_{LD} = 25^\circ$ C

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Characteristics at Begin Of Life cont'd

Parameter	Symbol	Unit	min	typ	max
Slope Efficiency	S	W / A	0.15	0.50	0.80
Threshold Current	I_{th}	mA			70
Sidemode Supression Ratio	SMSR	dB	30	45	
Mode-hop free Operating Range (SMSR > 30 dB)					
▶ Variant 0	T_{LD}	° C	24	25	26
	P_{opt}	mW	36		40
▶ Variant 1	T_{LD}	° C	24	25	26
	P_{opt}	mW	4		40
▶ Variant 2	T_{LD}	° C	15		45
	P_{opt}	mW	4		40
▶ Variant 5	λ_c	nm		780.24	
	P_{opt}	mW	36		40
Polarization Extinction Ratio	PER	dB		20	

Measurement Conditions / Comments

$T_{LD} = 25^\circ C$

$T_{LD} = 25^\circ C$

see below

see order code scheme on p. 4

wavelength reached within $T_{LD} = 5^\circ$ and $45^\circ C$

$P_{opt} = 40 mW; T_{LD} = 25^\circ C$

Monitor Diode

Parameter	Symbol	Unit	min	typ	max
Monitor Detector Responsivity	I_{mon} / P_{opt}	$\mu A / mW$	1		20
Reverse Voltage Monitor Diode	U_{RMD}	V	3		5

Measurement Conditions / Comments

$U_R = 5 V$, target values

Thermoelectric Cooler

Parameter	Symbol	Unit	min	typ	max
Current	I_{TEC}	A		0.4	
Voltage	U_{TEC}	V		0.8	
Power Dissipation (total loss at case)	P_{loss}	W		0.5	
Temperature Difference	ΔT	K			50

Measurement Conditions / Comments

$P_{opt} = 40 mW, \Delta T = 20 K$

$P_{opt} = 40 mW, \Delta T = 20 K$

$P_{opt} = 40 mW, \Delta T = 20 K$

$P_{opt} = 40 mW, \Delta T = |T_{case} - T_{LD}|$

Thermistor (Standard NTC Type)

Parameter	Symbol	Unit	min	typ	max
Resistance	R	kOhm		10	
Beta Coefficient	β			3892	

Measurement Conditions / Comments

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Fiber and Connector Type

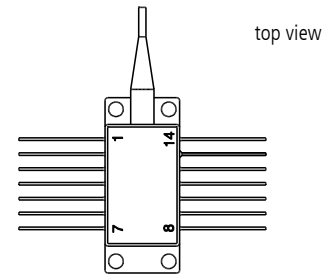
PM Fiber	900 / 125 / 5.5 μ m, UV/Polyester-elastomer Coating (l = 1 +/-0.1 m)
Connector	different variants available <ul style="list-style-type: none"> ▶ FC/APC (narrow key / 2mm) ▶ SC/APC ▶ other types on request

Measurement Conditions / Comments

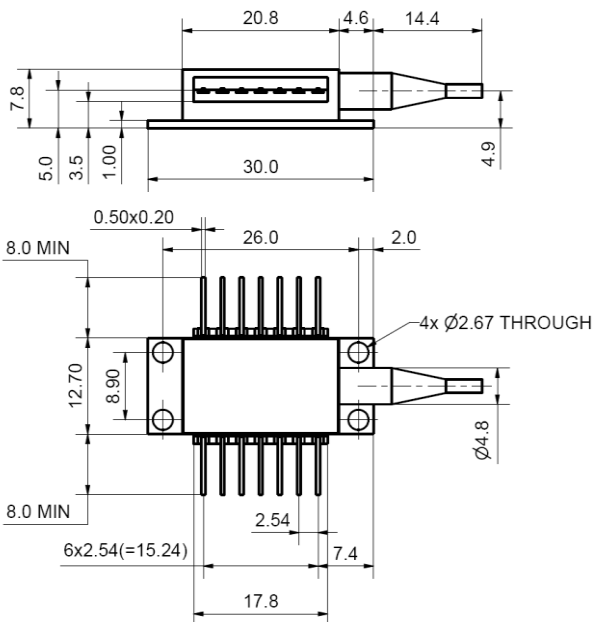
see order code scheme

Package Pinout

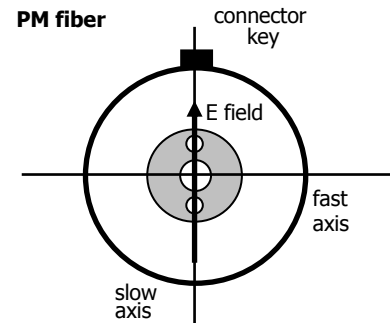
1	Thermoelectric Cooler (+)	14	Thermoelectric Cooler (-)
2	Thermistor	13	Case
3	Photodiode (Anode)	12	not connected
4	Photodiode (Cathode)	11	Laser Diode (Cathode)
5	Thermistor	10	Laser Diode (Anode)
6	not connected	9	not connected
7	not connected	8	not connected



Package Drawings



recommended
min. bending radius: 30 mm



slow axis of the PM fiber aligned to connector key

hermetically sealed Package:

Leak Rate <math> < 5 \cdot 10^{-8}</math> atm.cc./s
acc. MIL-STD-883E

Z11-SPEC-BFY02-DFB-0000

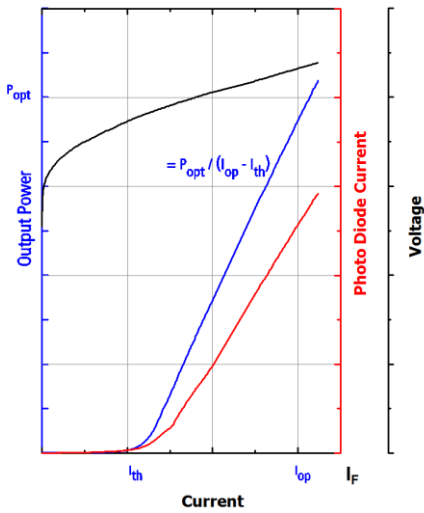
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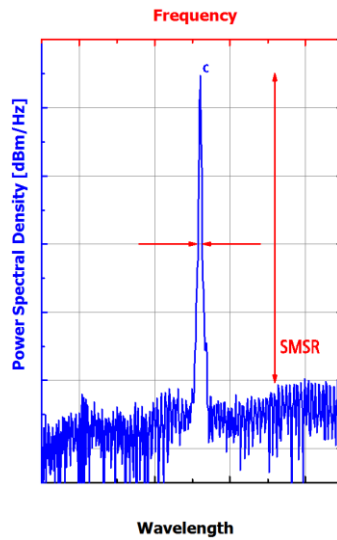


Typical Measurement Results

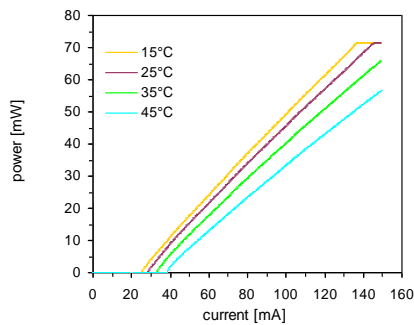
Output Power vs. Current



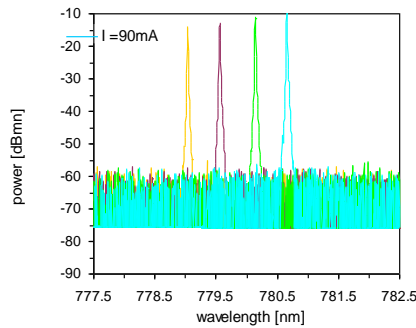
Spectra at Specified Optical Output Power



Output Power vs. Current over temperature



Spectra at Specified Optical Output Power over temperature



Performance figures, data and any illustrative material provided in this specification are typical and must be specifically confirmed in writing by eagleyard Photonics before they become applicable to any particular order or contract. In accordance with the eagleyard Photonics policy of continuous improvement specifications may change without notice.

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Order Code Scheme

Connector

FC/APC (narrow key / 2mm)

SC/APC

other connector or fiber types upon request

Mode-hop free Operating Range (Minimum Side Mode Suppression Ratio > 30 dB)

$P_{opt} = 36 \dots 40 \text{ mW}$; $T_{LD} = 25^\circ$ (Variant 0)

$P_{opt} = 4 \dots 40 \text{ mW}$; $T_{LD} = 25^\circ$ (Variant 1)

$P_{opt} = 4 \dots 40 \text{ mW}$; $T_{LD} = 15^\circ \dots 45^\circ \text{ C}$ (Variant 2)

$P_{opt} = 36 \dots 40 \text{ mW}$; $\lambda_c = 780.24 \text{ nm}$ (Variant 5)

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0
1

0
1
2
5

Unpacking, Installation and Laser Safety

Unpacking the laser diodes should only be done at electrostatic safe workstations (EPA). Though protection against electro static discharge (ESD) is implemented in the laser package, charges may occur at surfaces. Please store this product in its original package at a dry, clean place until final use. During device installation, ESD protection has to be maintained.

The DFB diode type is known to be sensitive against optical feedback, so an optical isolator may be required in some cases. Operating at moderate temperatures on a proper metal heat sinks will contribute to stable operation and a long lifetime of the diode.

The laser emission from this diode is close to the invisible infrared region of the electromagnetic spectrum. Avoid direct and/or indirect exposure to the free running beam. Collimating the free running beam with optics as common in optical instruments will increase threat to the human eye.

Each laser diode will come with an individual test protocol verifying the parameters given in this document.

